



ATS3015 Datasheet

Actions® ATS3015™ QFN32

Bluetooth Audio Solution

**Low Power Solution for
Portable & Wireless
Audio Applications
Headphone and Earphone**

**RISC32 core Single-chip
Bluetooth 5.2**

Version: V1.4

2021-8-3

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Revision History

Date	Revision	Description
2020-4-27	V1.0	Initial version
2020-6-2	V1.1	Add performance parameters of BLE mode.
2020-8-25	V1.2	Change the company name to "Actions Technology Co., Ltd."
2020-10-9	V1.3	Modify the description of SARADC.
2021-8-3	V1.4	Upgrade Bluetooth version to BT5.2

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1 Introduction

1.1 Overview

Actions' ATS3015 is a highly integrated single-chip Bluetooth Audio solution. Targeting at Bluetooth headsets and earphones market, ATS3015 satisfies the market requirements with high performance, low cost and low power consumptions.

ATS3015 adopts RISC32 core architecture. Large capacity RAM is embedded to meet different Bluetooth applications. ATS3015 supports decoding Bluetooth A2DP audio and loading sound effects simultaneously, supports Bluetooth handfree calls with microphone AEC and noise reduction.

ATS3015 integrates Bluetooth controller support BT5.2 and compliant with BT4.2/4.2 LE/4.0 Bluetooth specification, and supports dual mode (BR/EDR + Low Energy Controllers). The links in BR/EDR and LE can be active simultaneously.

ATS3015 take special methods at power optimization, especially for various applications scenarios, including sniff, Bluetooth idle, Bluetooth playing and call modes. Embedded PMU supports power optimization and provide long battery life. The competitive advantages of ATS3015 are high music and call qualities with low power and BOM, which lays the foundation for our goal at high-end market. Above all, ATS3015 provides a true "ALL-IN-ONE" solution, making it the ideal choice for highly integrated and optimized Bluetooth audio products.

1.2 Key Features

System

- 200MHz 32bit RISC processor Core
- Internal 188K RAM for data and program
- Internal ROM for firmware implementation
- Internal 4M bits SPI serial Flash for custom defined software
- Support 24MHz OSC with on-chip PLL
- Operating voltage: I/O 3.3V, Core 1.2V
- Fully configurable PEQ, up to 14 segments
- Support for echo cancellation and noise reduction
- Support for wind noise reduction
- Support for packet loss concealment
- Support for voice prompt

Bluetooth

- Support Bluetooth5.2, compatible with Bluetooth4.2/4.2 LE/4.0/2.1 + EDR system
- Max transmitting output power: 10dBm
- Bluetooth receiving sensitivity:
-95dBm@GFSK, -95dBm@π/4 DQPSK,
-86dBm@8DPSK modulation
- Compatible with AVRCP Profile V1.6
- Compatible with A2DP Profile V1.3
- Compatible with HFP Profile V1.7
- TWS two earphones can switch between master and slave at will
- Support for SBC & AAC Bluetooth audio transmission format
- Support for mSBC broadband speech coding
- Supports all packet types in basic rate and enhanced data rate
- Supports SCO/eSCO link
- Supports Secure Simple Pairing
- Supports Low Power Mode (Sniff / Sniff Sub-rating / Hold / Park)
- Bluetooth Dual Mode support: Simultaneous LE and BR / EDR
- Supports multiple Low Energy states
- Fast AGC control to improve receiving dynamic range
- Supports AFH to dynamically detect channel quality to improve transmission quality
- Supports Power/Enhanced Power Control
- LE Data Packet Length Extension
- Extended Scanner Filter Policies
- LE 2M PHY
- LE Extended Advertising
- LE Periodic Advertising
- Channel Selection Algorithm #2

Audio

- Build in mono 16-bit input sigma-delta ADC, SNR>85dB, THD+N<-81dB
- ADC supports sample rate 8k/12k/11.025k/
16k/22.05k/24k/32k/44.1k/48kHz
- Supports mono input analog microphone
- Supports two digital microphones
- Supports stereo single-ended line in
- Build in stereo 20-bit input sigma-delta DAC, SNR>98dB, THD+N<-84dB
- DAC supports sample rate 8k/12k/11.025k/
16k/22.05k/24k/32k/44.1k/48k/96kHz
- Build in stereo 18mW PA for headphone
- Support I2S TX with master mode, sampling rate from 8KHz to 96KHz
- Support I2S RX , sampling rate from 8KHz to 48KHz

Power Management

- Supports Li-Ion battery and 5V power supply
- Supports 5V power supply plugged in reset
- Integrated linear battery charger up to 300mA charging current, which supports CC/CV mode, does not support charging battery directly
- Integrated Low precision A/D converters for battery voltage monitor, temperature monitor and wire-controller
- Energy saving with dynamic power management
- Integrated DC-DC buck converters, which can be switch to LDO mode
- Supports DC5V insertion detection
- Supports DC5V pull out detection
- Low Power Consumption:
A2DP TWS: 6mA(Min)@Vbat = 3.8V
HFP TWS: 8.3mA@Vbat=3.8V
Typical Sniff Current: 300μA@500ms
Deep sleep: <1μA@Vbat = 3.8V

Physical Interfaces

- Support 10 GPIO
- Support 10-bits SARADC
- Support 5 PWM for lamp controller
- Serial Interface: SPI*2, UART*2, I2C*2

Package

- QFN-32 (4*4*0.75mm, Pitch 0.4mm)

1.3 Application Diagram

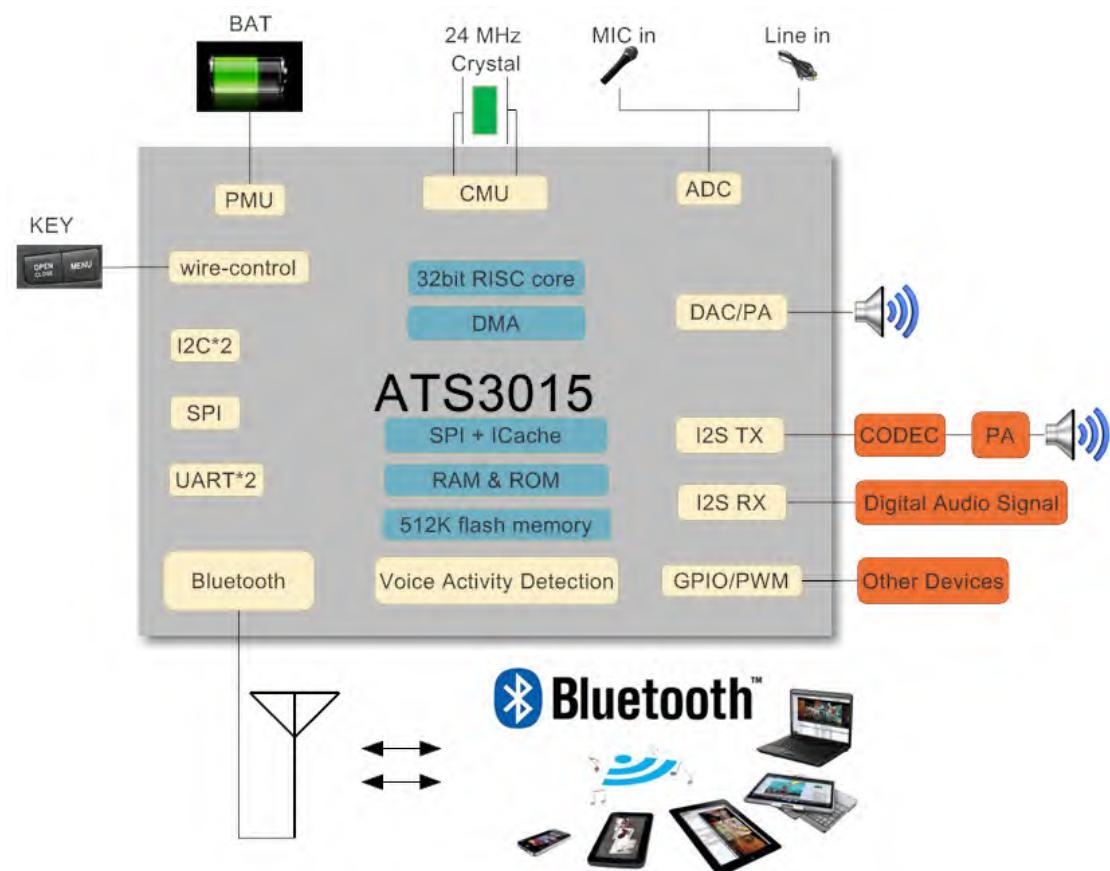
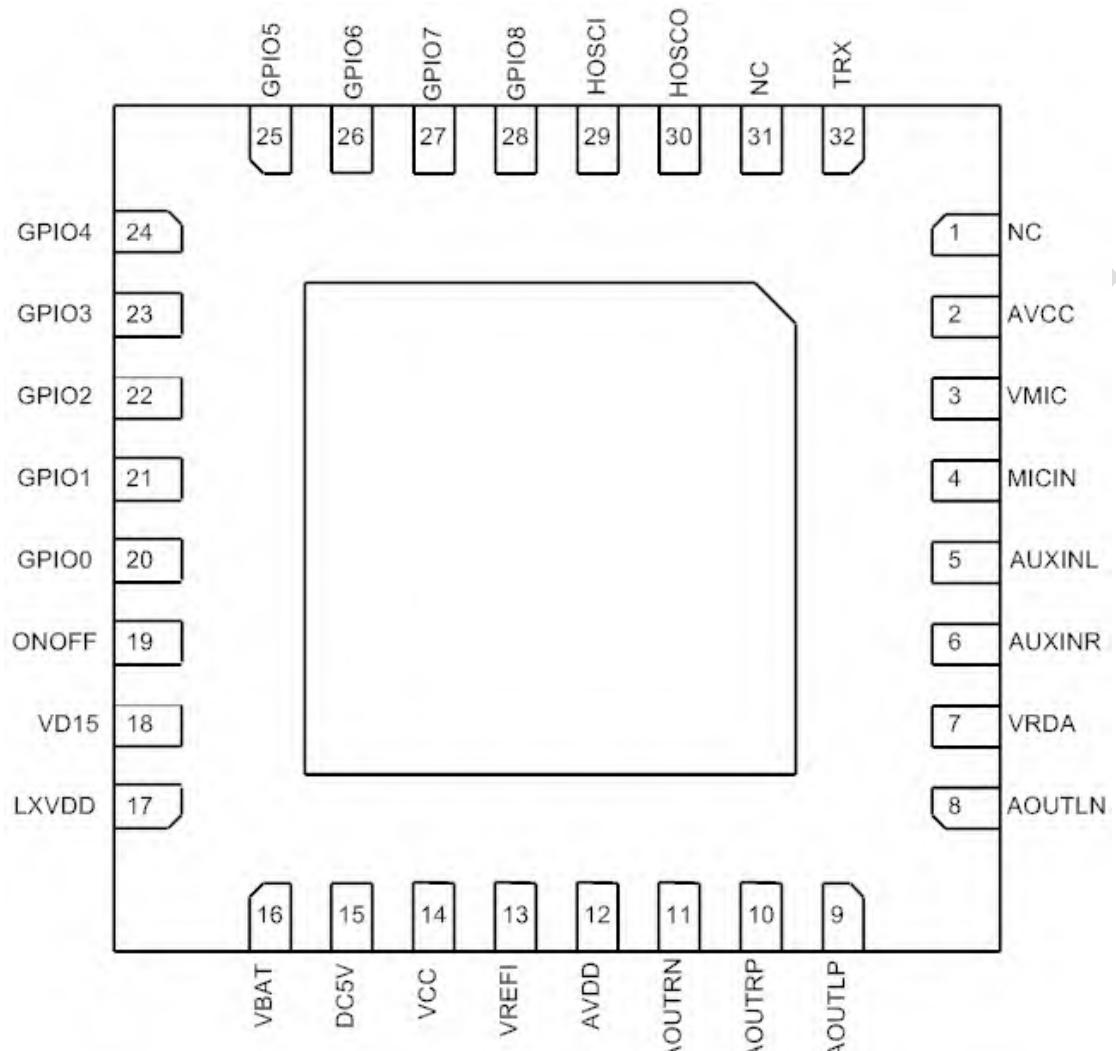


Figure 1-1 ATS3015 Application Diagram

1.4 Pin Assignment and Descriptions

1.4.1 Pin Assignment



1.4.2 Pin Description

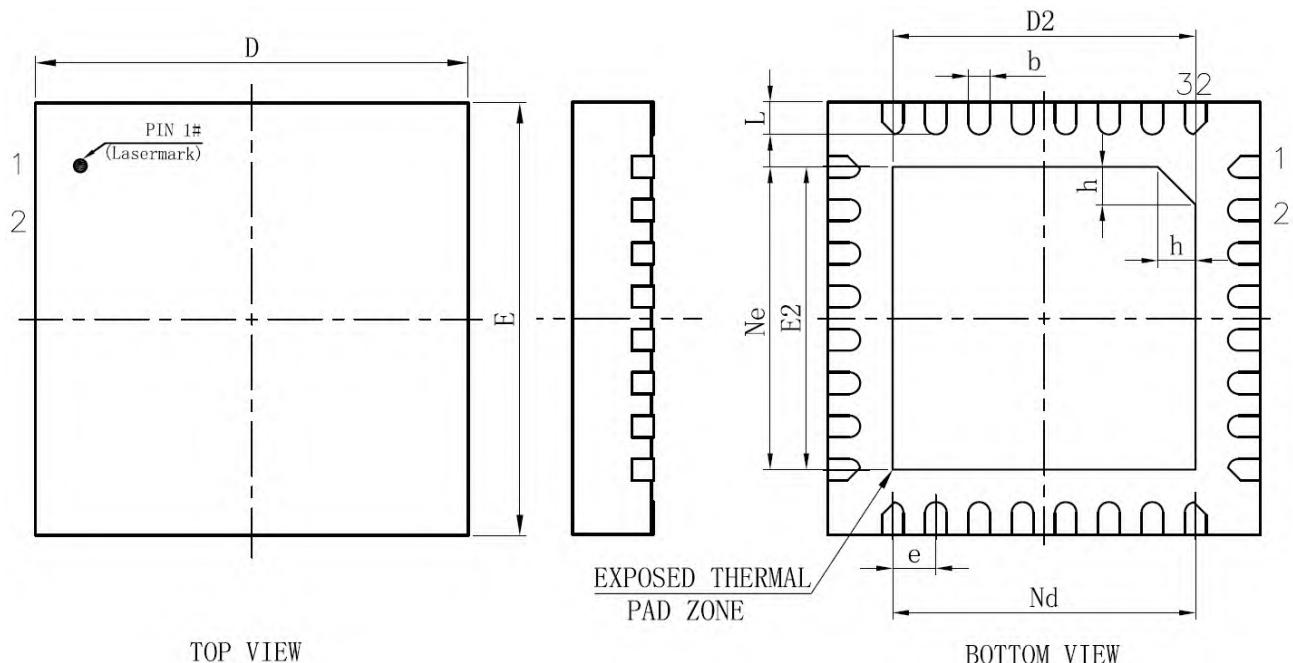
Pin No.	Pin Name	Function Multiplex	IO Type	PAD Drive Level	GPIO Initial State	Description
1	NC					
2	AVCC		PWR			2.95v voltage
3	VMIC	GPIO9 PWM3 SIRQ I2C0_SDA DMIC_CLK UART0_RX I2C1_SDA	DIO	2/4/8/10 mA	Z	VMIC(MIC power) or General purpose I/O
4	MICIN	DMIC_DAT	AI/DIO			Microphone input
5	AUXINL		AIO			Left channel of AUX input
6	AUXINR		AIO			Right channel of AUX input
7	VRDA		PWR			AUDIO power
8	AOUTLN		AIO			Left channel of AUDIO Analog output
9	AOUTLP		AIO			Right channel of AUDIO Analog output
10	AOUTRP		AIO			
11	AOUTRN		AIO			
12	AVDD		PWR			1.2v voltage
13	VREFI		PWR			Reference Voltage input
14	VCC		PWR			Digital power pin
15	DC5V		PWR			5.0V Voltage
16	VBAT		PWR			Battery Voltage input.
17	LXVDD		PWR			LXVDD
18	VD15		PWR			1.5v voltage
19	ONOFF		PWR			ON/OFF reset signal
20	GPIO0	SARADC UART0_TX UART1_TX I2C1_SDA SDC_CLK	DIO	2/4/8/10 mA	Z	General purpose I/O
21	GPIO1	PWM0 UART0_TX I2C0_SCL	DIO	2/4/8/10 mA	Z	General purpose I/O
22	GPIO2	PWM1 UART0_RX I2C0_SDA DMIC_CLK	DIO	2/4/8/10 mA	Z	General purpose I/O
23	GPIO3	PWM2 UART0_CTS UART0_TX I2STX_MCLK I2SRX_MCLK I2C1_SCL	DIO	2/4/8/10 mA	Z	General purpose I/O
24	GPIO4	PWM3 UART0_RTS UART0_TX UART1_RX I2STX_LRCLK I2SRX_LRCLK	DIO	2/4/8/10 mA	Z	General purpose I/O

25	GPIO5	PWM4 SPI1_CLK UART1_CTS I2STX_BCLK I2SRX_BCLK	DIO	2/4/8/10 mA	Z	General purpose I/O
26	GPIO6	PWM0 SIRQ UART1_RTS SPI1_SS I2STX_DOUT I2SRX_DIN	DIO	2/4/8/10 mA	Z	General purpose I/O
27	GPIO7	PWM1 I2C0_SCL DMIC_DAT DMIC12_DAT SPI1_MOSI	DIO	2/4/8/10 mA	Z	General purpose I/O
28	GPIO8	PWM2 SARADC DMIC12_CLK I2C0_SDA I2C1_SCL SPI1_MISO	DIO	2/4/8/10 mA	Z	General purpose I/O
29	HOSCI		AI			24MHz clock input
30	HOSCO		AO			24MHz clock output
31	NC					
32	TRX		RF			Bluetooth antenna IO
33	EPAD		GND			Exposed pad as ground

Note:

1. Z: high resistance;
2. There are two pull-up ($100\text{k}\Omega/10\text{k}\Omega$) and one pull-down ($100\text{k}\Omega$) configurable resistance for the GPIO0 to GPIO9.

1.4.3 Package Dimensions



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
b	0.15	0.20	0.25
c	0.18	0.20	0.25
D	3.90	4.00	4.10
D2	2.70	2.80	2.90
e	0.40BSC		
Ne	2.80BSC		
Nd	2.80BSC		
E	3.90	4.00	4.10
E2	2.70	2.80	2.90
L	0.25	0.30	0.35
h	0.30	0.35	0.40
L/F载体尺寸	122X122		

2 Bluetooth

2.1 Features

- Support Bluetooth V5.2
- Compatible with Bluetooth V4.2/V4.2 LE/V3.0/V2.1 +EDR systems
- Supports all packet types in basic rate and enhanced data rate
- Support Bluetooth transceiver
- Supports SCO/eSCO link
- Supports Secure Simple Pairing
- Supports Low Power Mode (Sniff / Sniff Sub-rating / Hold / Park)
- Bluetooth Dual Mode support: Simultaneous LE and BR / EDR
- Supports multiple Low Energy states
- Fast AGC control to improve receiving dynamic range
- Supports AFH to dynamically detect channel quality to improve transmission quality
- Supports GFSK, $\pi/4$ DQPSK and 8DPSK modulation
- Supports Power / Enhanced Power Control

2.2 Bluetooth V5.2 Features

- LE Data Packet Length Extension
- LE 2M PHY
- Channel Selection Algorithm #2

2.3 Bluetooth Performance

- Max transmitting output power: 10dBm
- Bluetooth receiving sensitivity: -95dBm@GFSK, -95dBm@ $\pi/4$ DQPSK, -86dBm@8DPSK modulation

3 Processor Core

- 200MHz RISC32 processor Core
- 32-bit Address and Data Paths
- RISC32-Compatible Instruction Set
- RISC32 Enhanced Architecture (Release 2) Features
- RISC16e™ Code Compression

4 Memory Controller

The memory controller provides dynamically allocated ring buffers that hold the data that is in transit between the host and the air. The dynamic allocation of memory ensures efficient use of the available RAM and is performed by hardware to minimize the overheads on the processor during data/voice transfers. The use of DMA ports also helps with efficient transfer of data to other peripherals.

- Full synchronous design with operation clock rate up to 200MHz.
- Internal 32KB CPU ICache for SPI NorFlash, which can be switched to 32K SRAM when Cache is useless.
- Internal 188KB SRAM for data and program
- On-chip 4M bits serial Flash for custom defined software. Users can download program by UART.

- It is accessible for all the RAM blocks through DMA.
- Arbitrate the priority of CPU and DMA access internal RAM simultaneously.
- It is accessible for all the RAM and ROM block through CPU' data bus and program bus.

5 DMA Controller

- Support for memory-to-memory, memory-to-peripheral, and peripheral-to-memory.
- 7-channel ordinary DMA, including DMA0, DMA1, DMA2, DMA3, DMA4, DMA5, DMA6 supports for transmission in burst 8 mode. Only one of the DMA channels can transfer data at the same time.
- DMA0/DMA1/DMA2/DMA3/DMA4/DMA5/DMA6 transmission can be triggered on the occurrence of selected events as following: memory, baseband TX & RX, modem, UART0 RX & TX, UART1 RX & TX, SPI0 RX & TX, SPI1 RX & TX, ADC, DMIC, I2S RX & TX, DAC.
- Each channel can send two interrupts to the CPU on completion of certain operational events.
- Transmission width includes 16-bit, and 32-bit, which is determined by DMA transmission type as following:
 - 8-bit: UART
 - 16-bit: ADC, DAC, I2S RX & TX, DMIC
 - 32-bit: memory, BT-baseband, BT-modem, I2S RX, DMIC

6 PMU

6.1 Features

The ATS3015 integrates a comprehensive power supply system, including the following features:

- Supports Li-Ion battery and 5V power supply
- Supports 5V power supply plugged in reset
- Supports standby current <1uA and power on button
- Integrated linear battery charger, which supports CC/CV mode, do not support charging battery directly
- Integrated DC-DC buck converters output VD15
- Integrated linear regulators output VCC, AVCC, and AVDD
- Integrated Low precision A/D converters for battery voltage monitor, temperature monitor and wire-controller
- Supports DC5V insertion detection
- Supports DC5V pull out detection

6.2 Module Description

6.2.1 DC-DC Converter

The DC-DC converter efficiently scales battery voltage to the required supply voltage. The DC-DC converters include several advanced features:

- Input power from BAT
- Low power consumption
- Synchronization DC-DC converter architecture
- Programmable output voltages 1.0~1.7V
- Work in Pulse Frequency Modulation (PFM) or Pulse-Width Modulation (PWM) automatically for different load current
- Support 2.2uH and 4.7uH power inductor

- If the system is to operate from linear regulators or an external power supply, then the internal DC-DC converters are powered down automatically.

6.2.2 Linear Regulators

The ATS3015 integrates 3 linear regulators respectively generate VCC, AVCC, AVDD.

The output voltages are precisely within $\pm 2\%$, providing large currents with a significantly small dropout voltage within $\pm 5\%$. Table below shows data of maximum output current.

Table 6-1 Regulators Maximum Output Current

Block Name	Input Voltage(V)	Output Voltage(V)	Output Capacitor(uF)	Load Capacity@ voltage drop to 95%(mA)
VCC	BAT(2.8~4.3)	3.1	2.2	80
AVCC	VCC(3.1)	2.95	1	10
AVDD	VD15(1.5)	1.2	1	100

6.2.3 Li-Ion Cell Charger

ATS3015 integrate charger for Li-Ion battery from a 5V source connected to the DC5V pin. The battery charger is essentially a linear regulator that has current limit and voltage limits. The charger is enable defaulted.

There is 3 phases through all the charging process: When battery voltage is below 2.8V, the charger outputs only 20mA for pre-charge. When battery voltage is between 3.0V to 4.2V, this phase is called constant current charging phase. At this phase, the charging current is constant and the voltage of battery is going up slowly. When battery voltage arrives 4.2V, the battery voltage will be constant, and the charging current will be reduced gradually, this phase is called constant voltage phase.

One can programmatically monitor the battery voltage using the BATADC. The charger has its own voltage limiting that operates independently of the BATADC. But monitoring the battery voltage and DC5V voltage during the charge might be helpful for reporting the charge progress.

7 System Control

7.1 RMU

- The RMU (Reset Management Unit) can reset all the peripherals.
- The MCU can enter power-saving mode by setting the registers of RMU.
- Each module has a separate reset control unit.

7.2 CMU

- Support only one oscillator inputs: 24MHz
- Supply 3 PLLs and special clocks of all modules
- The 3 PLLs is SPLL, CORE PLL, and Audio PLL
- CORE PLL support spread spectrum

7.3 Timer

- Built-in a 32k oscillator
- Two Timers with IRQS using High frequency oscillator
- A watch dog which can be configured as IRQ or Reset

7.4 Exceptions and Interrupts Controller (INTC)

The ATS3015 use RISC32 processor. The ATS3015 also adds additional controller to manage up to 32 interrupt sources.

Table below shows all interrupt sources.

Interrupt Number	Sources	Type
0	BT_BASEBAND	High Level
1	DMA	High Level
2	Watch Dog	High Level
3	TIMER0	High Level
4	TIMER1	High Level
5	SPI0	High Level
6	UART0	High Level
7	SIRQ	High Level
8	BB_TWS	High Level
9	DAC_I2S TX	High Level
10	ADC	High Level
11	VAD	High Level
12	I2C0	High Level
13	Reserved	High Level
14	DMIC_I2S RX	High Level
15	UART1	High Level
16	Reserved	High Level
17	SPI1	High Level
18	I2C1	High Level
21~31	Reserved	High Level

8 Serial Interfaces

8.1 UART

ATS3015 contains two UART interfaces named UART0 and UART1. Each has the following features:

- 5-8 Data Bits and LSB first in Transmit and Received
- 1-2 Stop Bits
- Even, Odd, or No Parity
- 8 Byte Transmit and Receive FIFOs while both was in 16 levels depth
- Capable of speeds up to 6Mbps to other peripherals
- Support IRQ and DMA mode to transmit data
- Support RTS/CTS Automatic Hardware Flow Control to reduce interrupts to host system
- UART RX DMA counter for valid data in RAM

8.2 I2C

ATS3015 contains two I2C interfaces named I2C0 and I2C1. Each has the following features:

- Both master and slave functions support
- Support standard mode (100kbps) and fast-speed mode (400kbps)
- Support fifo and non_fifo mode when W/R the data
- The sequence of data or address transfer from MSB
- Only 7-bit address mode support

- 8 Bit x8 TX FIFO and 8Bit x8 RX FIFO

Pull-up resistors are required on both of the I2C signal lines as the I2C drivers are open drain typically external 2.2k-Ohm resistors are used to pull the signals up to VCC if not select internal pull-up resistor in standard and fast mode.

8.3 SPI

ATS3015 contains two SPI interfaces named SPI0 and SPI1. SPI0 is used to connect to NorFlash. SPI1 can be customized by customers.

- Support SPI normal mode: mode 0\1\2\3
- Only support normal 4 wire mode
- Support IRQ and DMA mode to transmit data

9 Audio Interfaces

9.1 ADC

- Built-in mono 16 bit input sigma-delta ADC, SNR>85dB, THD+N<-81dB
- ADC supports sample rate 8k/12k/11.025k/16k/22.05k/24k/32k/44.1k/48kHz
- Supports mono single-ended input analog microphone
- Supports digital microphones
- Supports stereo single-ended line in
- ADC and DMIC are mutually exclusive

9.2 DAC

- Built-in stereo 20 bit input sigma-delta DAC, SNR > 98dB, THD+N < -84dB
- DAC supports sample rate 8k/12k/11.025k/16k/22.05k/24k/32k/44.1k/48k/96kHz
- Built-in stereo 20mW PA(Power Amplifier) for headphone
- The PA output supports traditional mode (non-direct drive mode) and differential mode
- The Power Amplifier drive external Power Amplifier with low noise, low distortion

9.3 I2S TX

- Support I2S Transmitter(TX) with master mode
- I2S TX supports Sample Rate 8k/12k/11.025k/16k/22.05k/24k/32k/44.1k/48k/88.2k/96kHz

9.4 I2S RX

- Support with master mode and slave mode
- I2S RX supports Sample Rate 8k/12k/11.025k/16k/22.05k/24k/32k/44.1k/48kHz
- Support I2S/ left-justified/ right-justified/ TDM format, with 16/20/24 bit data width
- Support TDM 4/8 channel, with A/B mode
- Support sample rate auto detect in slave mode

10 GPIO and I/O Multiplexer

10.1 GPIO Features

GPIO (General Purpose Input /Output) and MFP:

GPIO can output 0 or 1 and detect the signal level of the external circuit. Each GPIO has its own enable control bit and data registers. But the PADs are limited, so MFP module is designed for multiplexing these PADs.

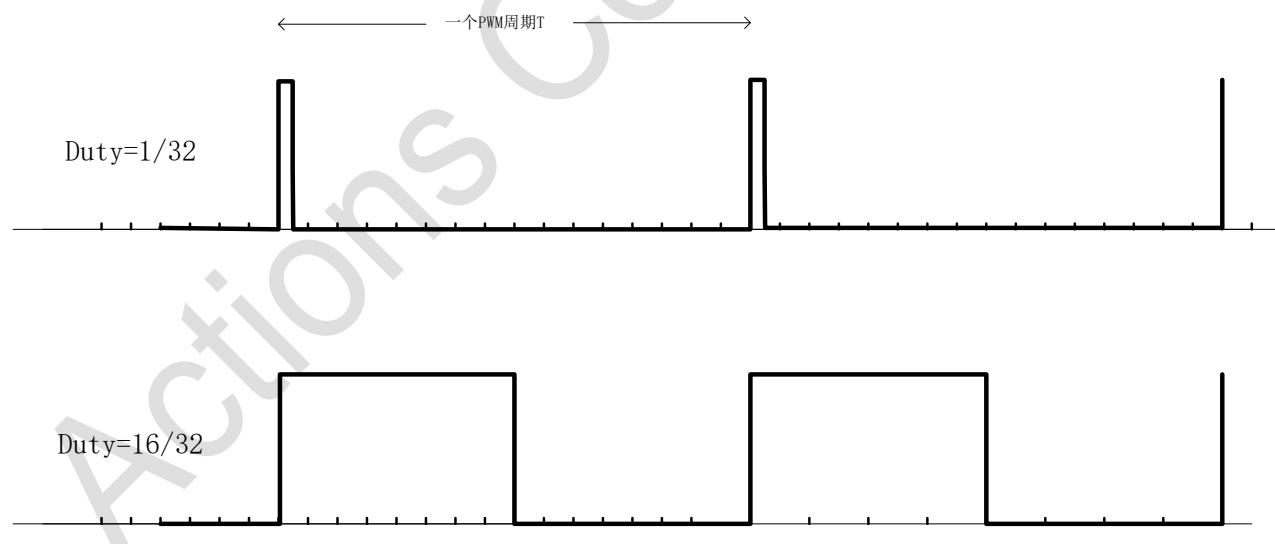
- Supports 10 GPIO
- Some PAD has internal pull down or pull up resistors
- Driving strength can be adjusted which has 4 Level
- Automatically switching PAD function
- The Schmitt trigger can be configured to open or close
- Support 5 channels PWM output
- An external interruption SIRQ

10.2 PWM

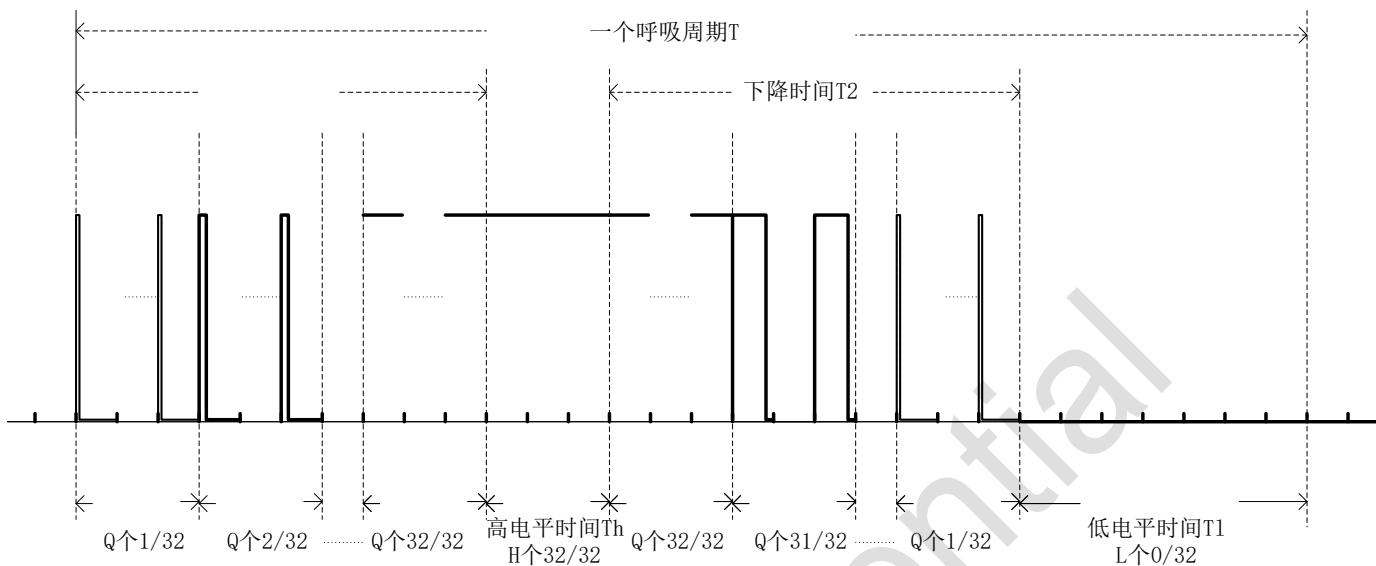
PWM output module is embedded in ATS3015, in the purpose of controlling the external backlight, indicator or Bluetooth Breath Led. It supplies widely variable output frequency from 32KHz to 24MHz and 32-level duty occupancy for precise adjustment.

There are five independent PWM can be used, namely PWM0, PWM1, PWM2, PWM3, PWM4. Each PWM has two modes, namely Normal Mode and Breath Mode.

10.2.1 Normal Mode Timing



10.2.2 Breath Mode Timing



11 Electrical Characteristics

11.1 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Ambient Temperature	Tamb	TBD	TBD	°C
Storage temperature	Tstg	-55	+150	°C
ESD Stress voltage	Vesd (Human body model)	4000	-	V
Supply Voltage	DC5V	-0.3	6	V
	BAT	-0.3	4.5	V
	VCC /AVCC	-0.3	3.6	V
	AVDD	-0.3	1.5	V
Input Voltage	3.3V IO	-0.3	3.6	V

Note:

- 1) Even if one of the above parameters exceeds the absolute maximum ratings momentarily, the quality of the product may be degraded. The absolute maximum ratings, therefore, specify the value exceeding, which the product may be physically damaged. Use the product well within these ratings.
- 2) All voltage values are with respect to GND.

11.2 Recommended Power Supply

Supply Voltage	Min	Typ	Max	Unit
BAT (Li)	3.2	3.8	4.35	V
DC5V	4.5	5	6	V
VCC/AVCC	2.8	3.1	3.4	V
AVDD	1.08	1.2	1.32	V

11.3 DC Characteristics

DC Parameters for +3.3V IO PIN

Parameter	Symbol	MIN.	MAX.	Unit	Condition
Low-level input voltage	VIL		0.8	V	VCC = 3.1V Tamb = -10 to 70 °C
High-level input voltage	VIH	2.0		V	
Low-level output voltage	VOL		0.4	V	
High-level output voltage	VOH	2.4		V	

11.4 Battery Charger

Parameter	Min.	Typ.	Max.	Unit
Input Voltage	BAT+0.1	5	6	V
Charge Current (CC Mode)	10	60	300	mA
Trickle Charge Current	-	20	-	mA
Trickle Charge Threshold Voltage	-	2.8	-	V
Regulated Output (Float) Voltage	3.3	4.2	4.35	V

11.5 Power Consumption

VDD = 1.2V @ 25°C, without speaker and led loading, RF TX power = +6dBm, Vbat = 3.8V

Parameter	Condition	Min.	Typ.	Max.	Unit
A2DP	TWS, SBC bit pool = 49	-	7.5	-	mA
HFP	TWS, Sample Rate 16KHz	-	8.3	-	mA
Sniff Mode	500ms	-	-	300	µA
Deep Sleep	Vbat = 3.8V	0.1	-	1	µA

11.6 Bluetooth Characteristics

11.6.1 Transmitter BT Classic Basic Data Rate(BDR)

Parameter	Condition	Min.	Typ.	Max.	Unit
Maximum RF Transmit PWR	-	-	8	10	dBm
RF PWR Control Step	-	2	4	8	dB
20dB Bandwidth for Modulated Carrier	-	-	914	1500-	KHz
Adjacent Channel Transmit	+2 MHz	-		-20	dBm
	-2 MHz	-		-20	dBm
	+3 MHz	-		-40	dBm
	-3 MHz	-		-40	dBm
Frequency Deviation	Δf1avg Maximum Modulation	140	166	175	KHz
	Δf2max Maximum Modulation	115	130		KHz
	Δf1avg/Δf2avg	0.8	0.93		
Initial Carrier Frequency Tolerance	-	-75	10	75	KHz
Frequency Drift	DH1 Packet	-25	-4.5	25	KHz
	DH3 Packet	-40	-5.5	40	KHz
	DH5 Packet	-40	-5.5	40	KHz
Frequency Drift Rate	-	-20	3	20	KHz/50us
Harmonic Content	-	-	-40	-	dBm

11.6.2 Transmitter BT Classic Enhanced Data Rate(EDR)

Description	Min	Typ.	Max.	Unit
Maximum RF Transmit PWR		8	10	dBm
Relative Transmit PWR(EDR)	-4	-2.5	1	dB
$\pi/4$ DQPSK max carrier frequency stability $ \omega_0 $	-10	2	10	KHz
$\pi/4$ DQPSK max carrier frequency stability $ \omega_i $	-75	-3	75	KHz
$\pi/4$ DQPSK max carrier frequency stability $ \omega_0+\omega_i $	-75	-3	75	KHz
8DPSK max carrier frequency stability $ \omega_0 $	-10	-3	10	KHz
8DPSK max carrier frequency stability $ \omega_i $	-75	-3	75	KHz
8DPSK max carrier frequency stability $ \omega_0+\omega_i $	-75	-3	75	KHz
$\pi/4$ DQPSK Modulation Accuracy	RMS DEVM	6	20	%
	99% DEVM	99	100	%
	Peak DEVM		15	%
In-band spurious emissions	$F > F_0 + 3\text{MHz}$		-40	dBm
	$F < F_0 - 3\text{MHz}$		-40	dBm
	$F = F_0 + 3\text{MHz}$		-40	dBm
	$F = F_0 - 3\text{MHz}$		-40	dBm
	$F = F_0 + 2\text{MHz}$		-20	dBm
	$F = F_0 - 2\text{MHz}$		-20	dBm
	$F = F_0 + 1\text{MHz}$		-26	dBm
	$F = F_0 - 1\text{MHz}$		-26	dBm
EDR Differential Phase Encoding	99	100		%

11.6.3 Transmitter Bluetooth Low Energy(BLE) 1Mbps

Description	Min.	Typ.	Max.	Unit
Maximum RF Transmit PWR		8		dBm
In-band emissions	+2 MHz	-45	-20	dBm
	-2 MHz	-46	-20	dBm
	+3 MHz	-48	-30	dBm
	-3 MHz	-47	-30	dBm
Modulation Characteristics	$\Delta f_{1\text{avg}}$ Maximum Modulation	225	240	KHz
	$\Delta f_{2\text{max}}$ Maximum Modulation	185	240	KHz
	$\Delta f_{1\text{avg}}/\Delta f_{2\text{avg}}$	0.8	1	
Carrier Frequency Offset	-150	-5	150	KHz
Frequency Drift	-50	-3	50	KHz

11.6.4 Transmitter Bluetooth Low Energy(BLE) 2Mbps

Description	Min.	Typ.	Max.	Unit
Maximum RF Transmit PWR		8		dBm
Adjacent Channel Transmit	+2 MHz	-54	-20	dBm
	-2 MHz	-54	-20	dBm
	+3 MHz	-57	-30	dBm
	-3 MHz	-57	-30	dBm
Frequency Deviation	$\Delta f_{1\text{avg}}$ Maximum Modulation	450	500	KHz
	$\Delta f_{2\text{max}}$ Maximum Modulation	370	420	KHz
	$\Delta f_{1\text{avg}}/\Delta f_{2\text{avg}}$	0.8	0.84	
Carrier Frequency Offset	-150	-5	150	KHz
Frequency Drift	-50	-5	50	KHz

Frequency Drift Rate	-20	-3	20	KHz/50us
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11.6.5 Receiver BT Classic Basic Data Rate(BDR)

Description	Min.	Typ.	Max.	Unit
Sensitivity		-95		dBm
Maximum Input PWR at 0.1% BER	-20			dBm
Co-Channel Interface	-		11	dB
Adjacent Channel Selectivity C/I	$F = F_0 + 1\text{MHz}$	-	0	dB
	$F = F_0 - 1\text{MHz}$	-	0	dB
	$F = F_0 + 2\text{MHz}$	-	-30	dB
	$F = F_0 - 2\text{MHz}$	-	-30	dB
	$F = F_0 + 3\text{MHz}$	-	-40	dB
	$F = F_{\text{image}}$	-	-9	dB

11.6.6 Receiver BT Classic Enhanced Data Rate(EDR)

Description	Min.	Typ.	Max.	Unit
Sensitivity at 0.1% BER	$\pi/4$ DQPSK		-95	-
	8DPSK	-86	-	dBm
Maximum Input PWR at 0.1% BER	$\pi/4$ DQPSK	-20		dBm
	8DPSK	-20		dB
CO-Channel Interference	$\pi/4$ DQPSK	-	13	dB
	8DPSK	-	21	dB

11.6.7 Receiver Bluetooth Low Energy(BLE) 1Mbps

Description	Min.	Typ.	Max.	Specification
Sensitivity LE 1M (dBm)		-100		<-70
Maximum Input PWR at 0.1% BER	-10			-10
C/I (dB)	Co-channel	4		<21dB
	Adjacent 1Mhz	-6		<15dB
	Adjacent 2MHz	-44		<-17dB
	Adjacent >=3Mhz	-50		<-27dB
	Image interference	-45		<-9dB
	Imahe+/-1Mhz	-52		<-15dB
Blocking(dBm)	30Mhz~2000Mhz	-30		-30
	2000Mhz~2400MHz	-35		-35
	2500MHz~3000MHz	-35		-35
	3000MHz~12.75Ghz	-30		-30
Inter-Modulation	Payload length: 37, n: 3, Packets: 1500 RF Level: -64 dBm		-30	PER $\leq 30.8\%$ ≥ -50
	Payload length: 37, n: 4 Packets: 1500 RF Level: -64 dBm		-30	PER $\leq 30.8\%$ ≥ -50
	Payload length: 37, n: 5 Packets: 1500 RF Level: -64 dBm		-30	PER $\leq 30.8\%$ ≥ -50

11.6.8 Receiver Bluetooth Low Energy(BLE) 2Mbps

Description	Min.	Typ.	Max.	Specification
Sensitivity LE 2M(dBm)		-97		<-70
Maximum Input PWR at 0.1% BER	-10			-10
C/I (dB)	Co-channel	17		<21dB

	Adjacent 1Mhz	-7		<15dB
	Adjacent 2MHz	-47		<-17dB
	Adjacent >=3Mhz	-52		<-27dB
	Image interference	-43		<-9dB
	Image+/-2Mhz	-50		<-15dB
Blocking(dBm)	30Mhz~2000Mhz	-30		-30
	2000Mhz~2400MHz	-35		-35
	2500MHz~3000MHz	-35		-35
	3000MHz~12.75Ghz	-30		-30
Inter-Modulation	Payload length: 37, n: 3 Packets: 1500 RF Level: -64 dBm	-30		PER \leq 30.8% \geq -50
	Payload length: 37, n: 4 Packets: 1500 RF Level: -64 dBm	-30		PER \leq 30.8% \geq -50
	Payload length: 37, n: 5 Packets: 1500 RF Level: -64 dBm	-30		PER \leq 30.8% \geq -50

11.7 Audio ADC

Pre-Amplifier						
Parameter	Conditions		Min	Typ	Max	Unit
Full Scale Input Voltage	THD+N < 1%		-	-	0.56	Vpp
Analogue gain	AUX OP	-	-6	-	21	dB
	MIC OP	Single Ended	9	-	36	dB
Analogue to Digital Converter						
Resolution	-		-	-	16	Bits
Input Sample Rate	-		8	-	48	kHz
SNR	fin = 1kHz@1.0Vpp B/W = 22Hz~22kHz Fs=48kHz	-	-	85	-	dB
		A-Weighting	-	88	-	dB
Dynamic Range	fin = 1kHz@10m Vpp B/W = 22Hz~22kHz Fs=48kHz		-	85	-	dB
	fin = 1kHz(input=0.4Vpp) B/W = 22Hz~22kHz Fs=48kHz		-	-81	-	dB
Digital gain	-		0	-	12	dB

11.8 Stereo DAC

Digital to Analogue Converter						
Parameter	Conditions		Min	Typ	Max	Unit
Resolution	-		-	-	20	Bits
Output Sample Rate	-		8	-	96	kHz
SNR	fin = 1kHz@0dBFS input B/W = 22Hz~22kHz Fs=48kHz,Load=16Ω		-	98	-	dB
	A-Weighting	-	100	-	dB	
Dynamic Range	fin = 1kHz@-40dBFS input		-	92	-	dB

	B/W = 22Hz~22kHz Fs=48kHz,Load=16Ω	A-Weighting	-	94	-	dB
THD+N	fin = 1kHz@0dBFS input B/W = 22Hz~22kHz Fs=48kHz,Load=16Ω	-	-	-84	-	dB
Digital gain	-		<-60	-	30	dB
Stereo crosstalk	fin = 1kHz@0dBFS input	Differential output	-	-110	-	dB
PWR Amplifier						
Max Amplitude/PWR	fin = 1kHz@0dBFS input Fs=48kHz,Load=16Ω	Single Ended Output	-	-	283	mVrms
			-	-	5	mW
	fin = 1kHz@0dBFS input Fs=48kHz,Load=16Ω	Full Differential Output	-	-	566	mVrms
			-	-	20	mW
	fin = 1kHz@0dBFS input Fs=48kHz,Load=10KΩ	Full Differential Output	-	-	1.6	Vpp

Acronyms and Abbreviations

Abbreviations	Descriptions
AEC	acoustic echo cancellers
ADC	Analog to Digital Converter
AGC	Auto Gain Control
CMU	Clock Management Unit
DAC	Digital to Analog Converter
DMA	Direct Memory Access
GPIO	General Purpose Input Output
HOSC	High Frequency OSC (24MHz)
INTC	Interrupt Controller
IRQ	Interrupt Request
SARADC	Successive Approximation Register Analog to Digital Converter
MIC	Microphone
MFP	Multiple Function PAD
NMI	Nonmaskable Interrupt
OSC	Oscillator
PA	Power Amplifier
PMU	Power Management Unit
PWM	Pulse Width Modulation
RMU	Reset Management Unit
SIE	Serial Interface Engine
VAD	Voice Activity Detection
TWS	Ture Wireless Stereo

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